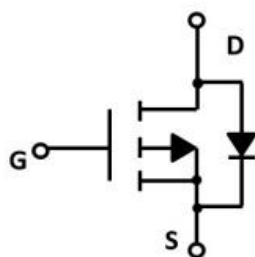
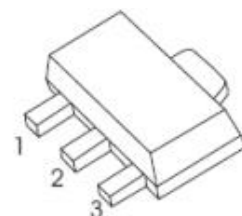


**SOT-89 -15V P Channel Enhancement 沟道增强型  
MOS Field Effect Transistor 场效应管**



- 1. Gate
- 2. Drain
- 3. Source



**■ Absolute Maximum Ratings 最大额定值**

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	$BV_{DSS}$	-15	V
Gate- Source Voltage 栅极-源极电压	$V_{GS}$	$\pm 12$	V
Drain Current (continuous)漏极电流-连续	$I_D$ (at $T_A = 25^\circ C$ )	-15	A
Drain Current (pulsed)漏极电流-脉冲	$I_{DM}$	-60	A
Total Device Dissipation 总耗散功率	$P_D$ (at $T_A = 25^\circ C$ )	3000	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	42	$^\circ C/W$
Junction/Storage Temperature 结温/储存温度	$T_J, T_{stg}$	-55~150	$^\circ C$

**■ Device Marking 产品字标**

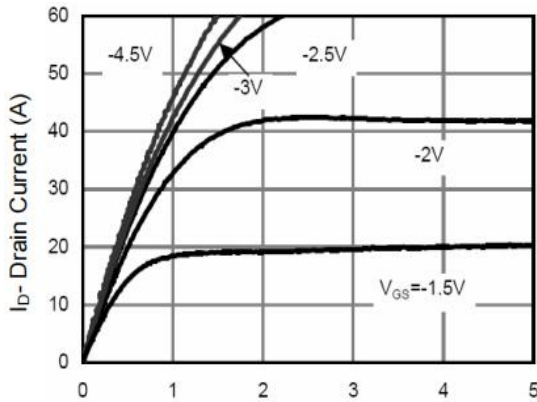
**FS15P02F=15P02**

■ **Electrical Characteristics 电特性**

( $T_A=25^{\circ}\text{C}$  unless otherwise noted 如无特殊说明, 温度为  $25^{\circ}\text{C}$ )

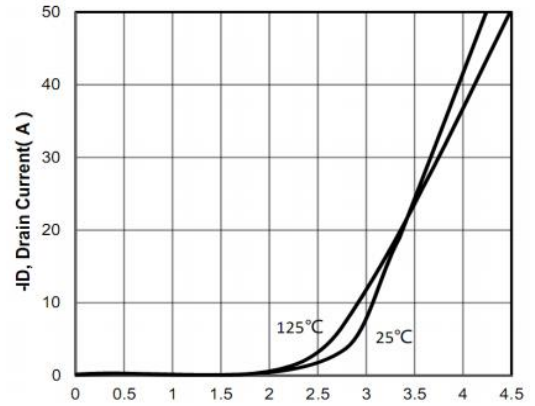
Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压( $I_D = -250\mu\text{A}, V_{GS}=0\text{V}$ )	$BV_{DSS}$	-15	-18	—	V
Gate Threshold Voltage 栅极开启电压( $I_D = -250\mu\text{A}, V_{GS} = V_{DS}$ )	$V_{GS(th)}$	-0.4	-0.65	-0.95	V
Zero Gate Voltage Drain Current 零栅压漏极电流( $V_{GS}=0\text{V}, V_{DS} = -12\text{V}$ )	$I_{DSS}$	—	—	-1	$\mu\text{A}$
Gate Body Leakage 栅极漏电流( $V_{GS}=\pm 12\text{V}, V_{DS}=0\text{V}$ )	$I_{GSS}$	—	—	$\pm 100$	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻( $I_D = -7\text{A}, V_{GS} = -4.5\text{V}$ ) ( $I_D = -5\text{A}, V_{GS} = -2.5\text{V}$ )	$R_{DS(ON)}$	—	12.5 17	18 23	$\text{m}\Omega$
Diode Forward Voltage Drop 内附二极管正向压降( $I_{SD} = -5\text{A}, V_{GS}=0\text{V}$ )	$V_{SD}$	—	—	-1.2	V
Input Capacitance 输入电容 ( $V_{GS}=0\text{V}, V_{DS} = -10\text{V}, f=1\text{MHz}$ )	$C_{ISS}$	—	2700	—	pF
Common Source Output Capacitance 共源输出电容( $V_{GS}=0\text{V}, V_{DS} = -10\text{V}, f=1\text{MHz}$ )	$C_{OSS}$	—	680	—	pF
Reverse Transfer Capacitance 反馈电容 ( $V_{GS}=0\text{V}, V_{DS} = -10\text{V}, f=1\text{MHz}$ )	$C_{RSS}$	—	590	—	pF
Total Gate Charge 栅极电荷密度 ( $V_{DS} = -6\text{V}, I_D = -9\text{A}, V_{GS} = -4.5\text{V}$ )	$Q_g$	—	35	—	nC
Gate Source Charge 栅源电荷密度 ( $V_{DS} = -6\text{V}, I_D = -9\text{A}, V_{GS} = -4.5\text{V}$ )	$Q_{gs}$	—	5	—	nC
Gate Drain Charge 栅漏电荷密度 ( $V_{DS} = -6\text{V}, I_D = -9\text{A}, V_{GS} = -4.5\text{V}$ )	$Q_{gd}$	—	10	—	nC
Turn-ON Delay Time 开启延迟时间 ( $V_{DS} = -10\text{V}, I_D = -1\text{A}, R_{GEN}=10\Omega, V_{GS} = -4.5\text{V}$ )	$t_{d(on)}$	—	11	—	ns
Turn-ON Rise Time 开启上升时间 ( $V_{DS} = -10\text{V}, I_D = -1\text{A}, R_{GEN}=10\Omega, V_{GS} = -4.5\text{V}$ )	$t_r$	—	35	—	ns
Turn-OFF Delay Time 关断延迟时间 ( $V_{DS} = -10\text{V}, I_D = -1\text{A}, R_{GEN}=10\Omega, V_{GS} = -4.5\text{V}$ )	$t_{d(off)}$	—	30	—	ns
Turn-OFF Fall Time 关断下降时间 ( $V_{DS} = -10\text{V}, I_D = -1\text{A}, R_{GEN}=10\Omega, V_{GS} = -4.5\text{V}$ )	$t_f$	—	10	—	ns

■ Typical Characteristic Curve 典型特性曲线



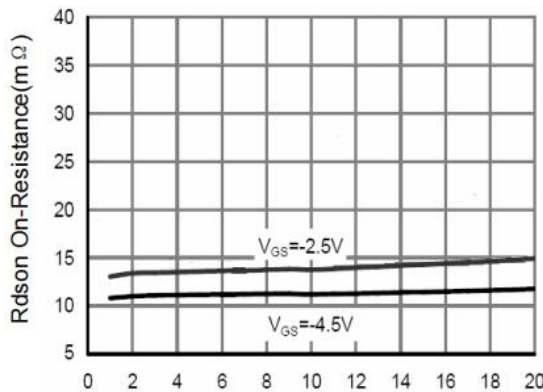
-V<sub>DS</sub> Drain-Source Voltage (V)

Figure 1: Output Characteristics



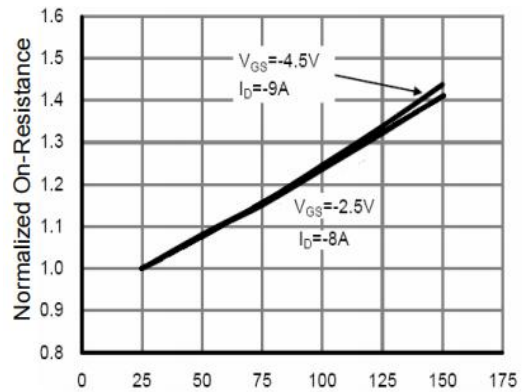
-V<sub>GS</sub> Gate-Source Voltage (V)

Figure 2: Transfer Characteristics



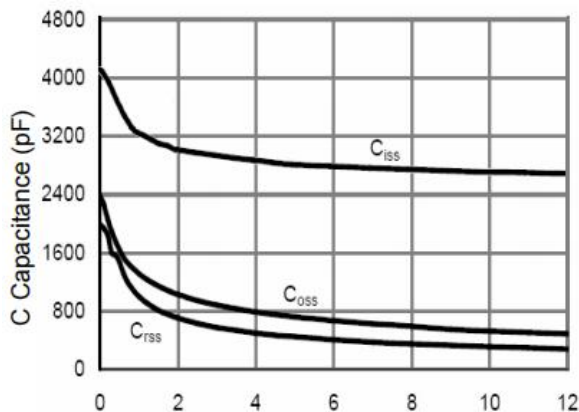
-I<sub>D</sub> Drain Current (A)

Figure 3: On-Resistance vs. Drain Current



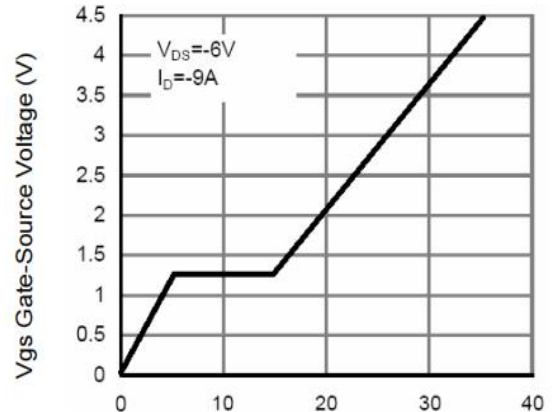
T<sub>J</sub> Junction Temperature (°C)

Figure 4: On-Resistance vs. Temperature



-V<sub>DS</sub> Drain-Source Voltage (V)

Figure 5: Capacitance Characteristics



Qg Gate Charge (nC)

Figure 6: Gate-Charge Characteristics

■ Typical Characteristic Curve 典型特性曲线

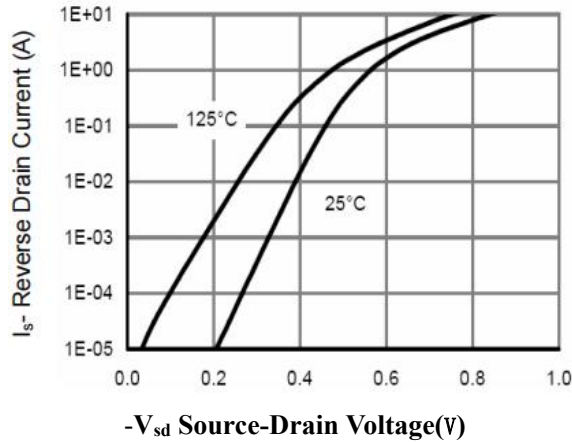


Figure 7: Body Diode Characteristics

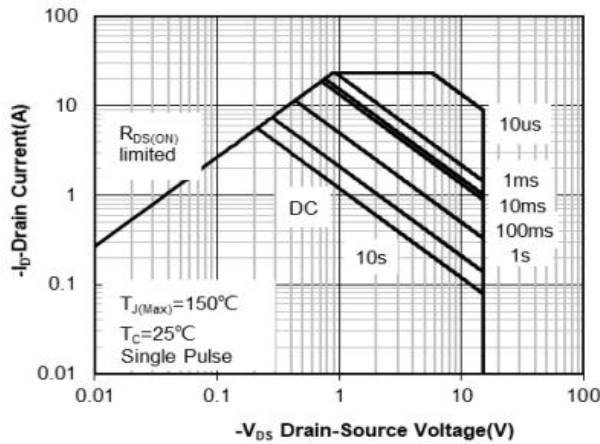


Figure8: Safe Operating Area

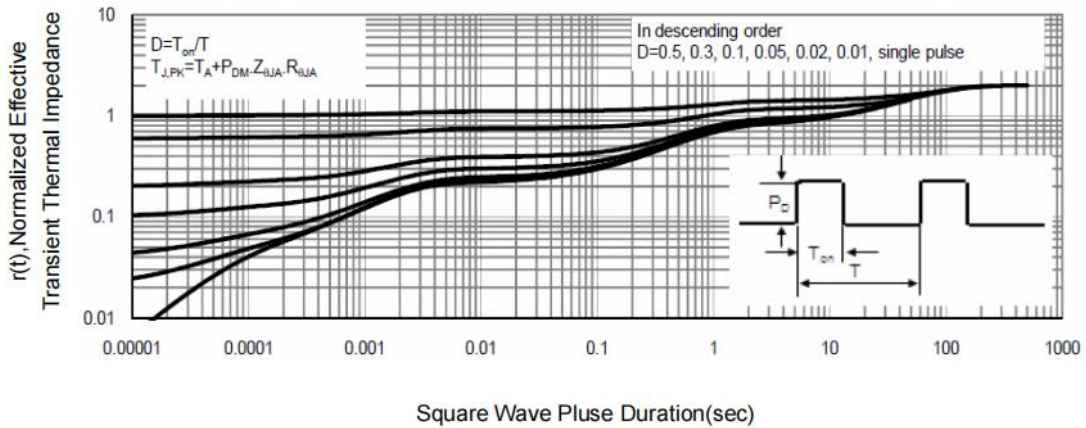
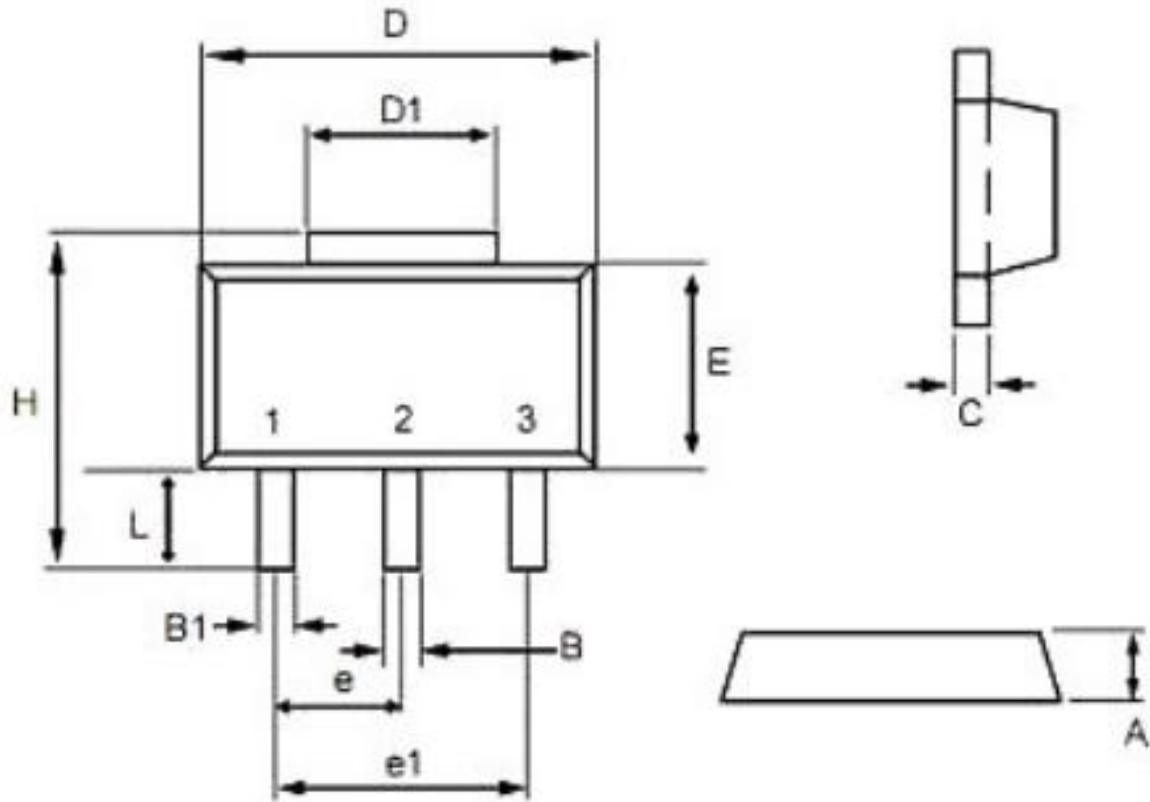


Figure 9: Transient Thermal Response Curve

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.40	1.60	0.055	0.063
B	0.40	0.56	0.016	0.022
B1	0.35	0.48	0.014	0.019
C	0.35	0.44	0.014	0.017
D	4.40	4.60	0.173	0.181
D1	1.35	1.83	0.053	0.072
e	1.45	1.55	0.057	0.061
e1	2.95	3.05	0.116	0.120
E	2.29	2.60	0.090	0.102
H	3.75	4.25	0.148	0.167
L	0.80	1.20	0.031	0.047